

# BC856ALT1G Series

## General Purpose Transistors

### PNP Silicon

#### Features

- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Rating                                                                                | Symbol    | Value             | Unit |
|---------------------------------------------------------------------------------------|-----------|-------------------|------|
| Collector-Emitter Voltage<br>BC856, SBC856<br>BC857, SBC857<br>BC858, NSVBC858, BC859 | $V_{CEO}$ | -65<br>-45<br>-30 | V    |
| Collector-Base Voltage<br>BC856, SBC856<br>BC857, SBC857<br>BC858, NSVBC858, BC859    | $V_{CBO}$ | -80<br>-50<br>-30 | V    |
| Emitter-Base Voltage                                                                  | $V_{EBO}$ | -5.0              | V    |
| Collector Current – Continuous                                                        | $I_C$     | -100              | mAdc |
| Collector Current – Peak                                                              | $I_C$     | -200              | mAdc |

#### THERMAL CHARACTERISTICS

| Characteristic                                                                                                      | Symbol          | Max         | Unit                       |
|---------------------------------------------------------------------------------------------------------------------|-----------------|-------------|----------------------------|
| Total Device Dissipation FR-5 Board,<br>(Note 1) $T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$        | $P_D$           | 225<br>1.8  | mW<br>mW/ $^\circ\text{C}$ |
| Thermal Resistance,<br>Junction-to-Ambient                                                                          | $R_{\theta JA}$ | 556         | $^\circ\text{C}/\text{W}$  |
| Total Device Dissipation Alumina<br>Substrate, (Note 2) $T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$           | 300<br>2.4  | mW<br>mW/ $^\circ\text{C}$ |
| Thermal Resistance,<br>Junction-to-Ambient                                                                          | $R_{\theta JA}$ | 417         | $^\circ\text{C}/\text{W}$  |
| Junction and Storage Temperature                                                                                    | $T_J, T_{stg}$  | -55 to +150 | $^\circ\text{C}$           |

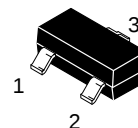
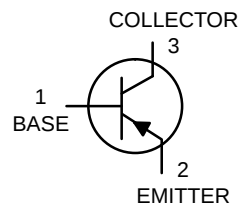
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.
2. Alumina =  $0.4 \times 0.3 \times 0.024$  in 99.5% alumina.



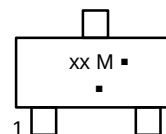
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SOT-23 (TO-236)  
CASE 318  
STYLE 6

#### MARKING DIAGRAM



xx = Device Code  
xx = (Refer to page 6)  
M = Date Code\*  
■ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

## BC856ALT1G Series

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic                                                                                                  | Symbol        | Min                  | Typ         | Max         | Unit                |
|-----------------------------------------------------------------------------------------------------------------|---------------|----------------------|-------------|-------------|---------------------|
| <b>OFF CHARACTERISTICS</b>                                                                                      |               |                      |             |             |                     |
| Collector–Emitter Breakdown Voltage<br>( $I_C = -10\text{ mA}$ )                                                | $V_{(BR)CEO}$ | -65<br>-45<br>-30    | -<br>-<br>- | -<br>-<br>- | V                   |
| Collector–Emitter Breakdown Voltage<br>( $I_C = -10\text{ }\mu\text{A}$ , $V_{EB} = 0$ )                        | $V_{(BR)CES}$ | -80<br>-50<br>-30    | -<br>-<br>- | -<br>-<br>- | V                   |
| Collector–Base Breakdown Voltage<br>( $I_C = -10\text{ }\mu\text{A}$ )                                          | $V_{(BR)CBO}$ | -80<br>-50<br>-30    | -<br>-<br>- | -<br>-<br>- | V                   |
| Emitter–Base Breakdown Voltage<br>( $I_E = -1.0\text{ }\mu\text{A}$ )                                           | $V_{(BR)EBO}$ | -5.0<br>-5.0<br>-5.0 | -<br>-<br>- | -<br>-<br>- | V                   |
| Collector Cutoff Current ( $V_{CB} = -30\text{ V}$ )<br>( $V_{CB} = -30\text{ V}$ , $T_A = 150^\circ\text{C}$ ) | $I_{CBO}$     | -<br>-               | -<br>-      | -15<br>-4.0 | nA<br>$\mu\text{A}$ |

### ON CHARACTERISTICS

|                                                                                                                                                   |               |                   |                   |                   |   |
|---------------------------------------------------------------------------------------------------------------------------------------------------|---------------|-------------------|-------------------|-------------------|---|
| DC Current Gain<br>( $I_C = -10\text{ }\mu\text{A}$ , $V_{CE} = -5.0\text{ V}$ )                                                                  | $h_{FE}$      | -<br>-<br>-       | 90<br>150<br>270  | -<br>-<br>-       | - |
| ( $I_C = -2.0\text{ mA}$ , $V_{CE} = -5.0\text{ V}$ )                                                                                             |               | 125<br>220<br>420 | 180<br>290<br>520 | 250<br>475<br>800 |   |
| Collector–Emitter Saturation Voltage<br>( $I_C = -10\text{ mA}$ , $I_B = -0.5\text{ mA}$ )<br>( $I_C = -100\text{ mA}$ , $I_B = -5.0\text{ mA}$ ) | $V_{CE(sat)}$ | -<br>-            | -<br>-            | -0.3<br>-0.65     | V |
| Base–Emitter Saturation Voltage<br>( $I_C = -10\text{ mA}$ , $I_B = -0.5\text{ mA}$ )<br>( $I_C = -100\text{ mA}$ , $I_B = -5.0\text{ mA}$ )      | $V_{BE(sat)}$ | -<br>-            | -0.7<br>-0.9      | -<br>-            | V |
| Base–Emitter On Voltage<br>( $I_C = -2.0\text{ mA}$ , $V_{CE} = -5.0\text{ V}$ )<br>( $I_C = -10\text{ mA}$ , $V_{CE} = -5.0\text{ V}$ )          | $V_{BE(on)}$  | -0.6<br>-         | -<br>-            | -0.75<br>-0.82    | V |

### SMALL–SIGNAL CHARACTERISTICS

|                                                                                                                                                                                                                            |          |        |        |           |     |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|--------|--------|-----------|-----|
| Current–Gain – Bandwidth Product<br>( $I_C = -10\text{ mA}$ , $V_{CE} = -5.0\text{ Vdc}$ , $f = 100\text{ MHz}$ )                                                                                                          | $f_T$    | 100    | -      | -         | MHz |
| Output Capacitance<br>( $V_{CB} = -10\text{ V}$ , $f = 1.0\text{ MHz}$ )                                                                                                                                                   | $C_{ob}$ | -      | -      | 4.5       | pF  |
| Noise Figure<br>( $I_C = -0.2\text{ mA}$ , $V_{CE} = -5.0\text{ Vdc}$ , $R_S = 2.0\text{ k}\Omega$ , $f = 1.0\text{ kHz}$ , $BW = 200\text{ Hz}$ )<br>BC856, SBC856, BC857, SBC857, BC858, NSVBC858 Series<br>BC859 Series | NF       | -<br>- | -<br>- | 10<br>4.0 | dB  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# BC856ALT1G Series

## BC857/BC858/BC859/SBC857/NSVBC858

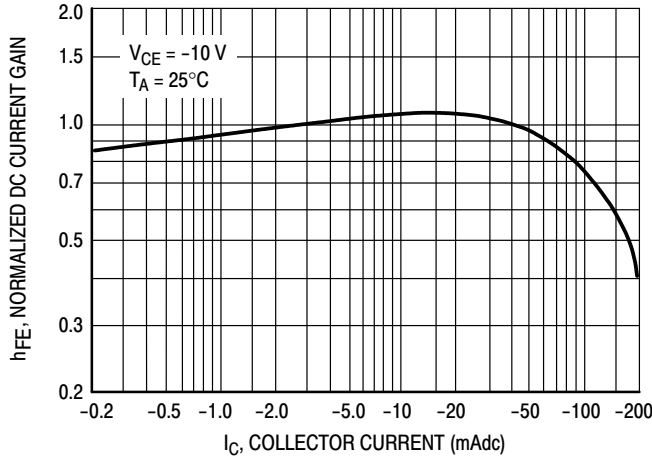


Figure 1. Normalized DC Current Gain

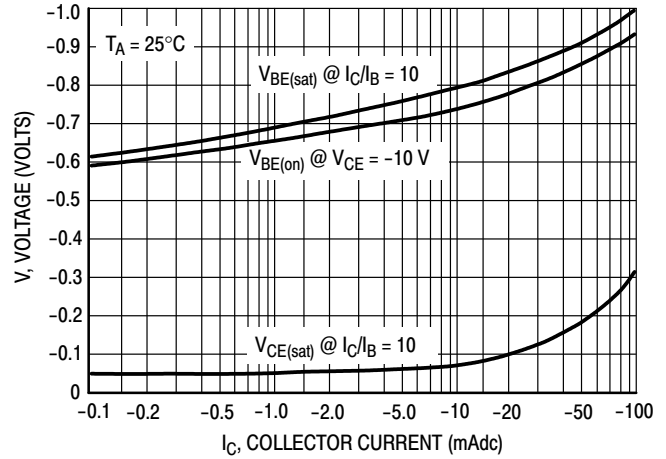


Figure 2. "Saturation" and "On" Voltages

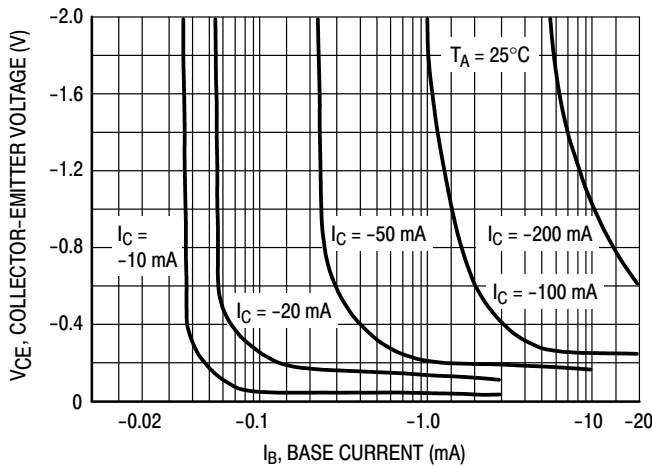


Figure 3. Collector Saturation Region

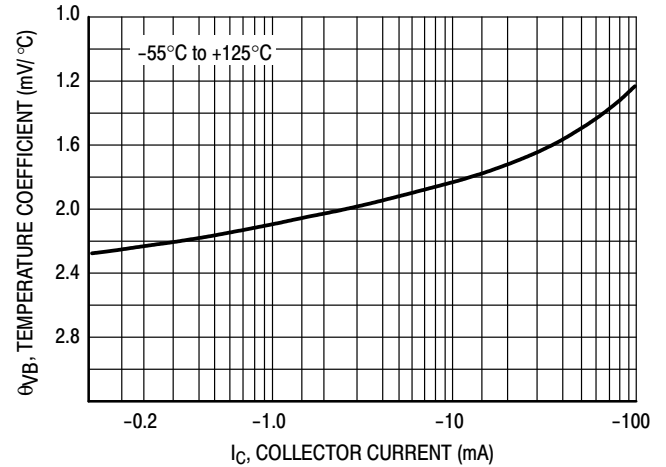


Figure 4. Base-Emitter Temperature Coefficient

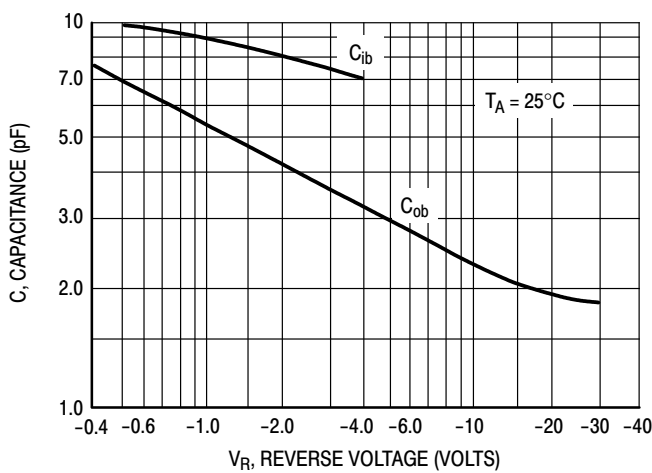


Figure 5. Capacitances

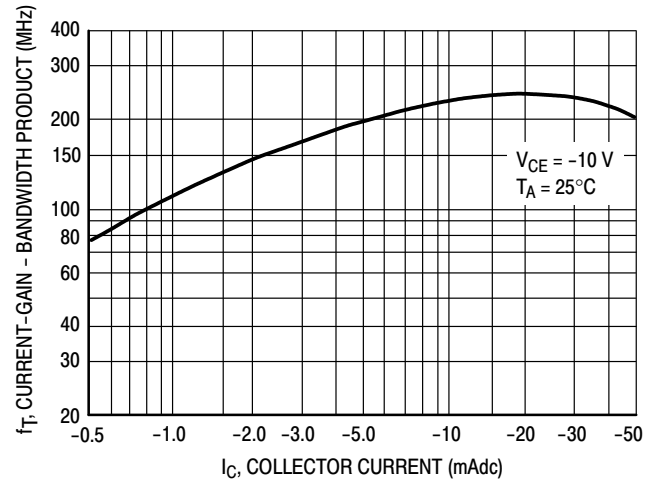


Figure 6. Current-Gain - Bandwidth Product

# BC856ALT1G Series

## BC856/SBC856

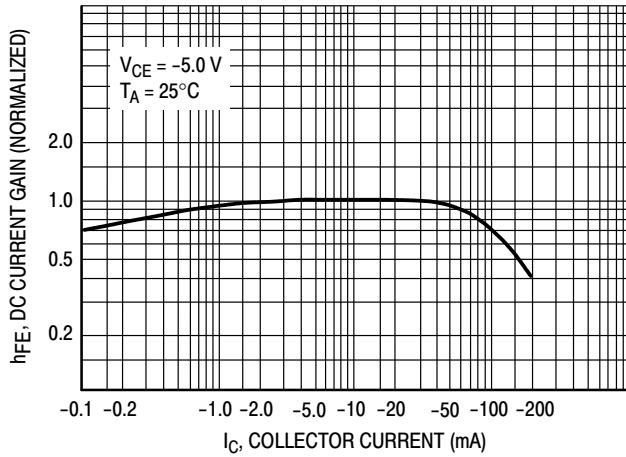


Figure 7. DC Current Gain

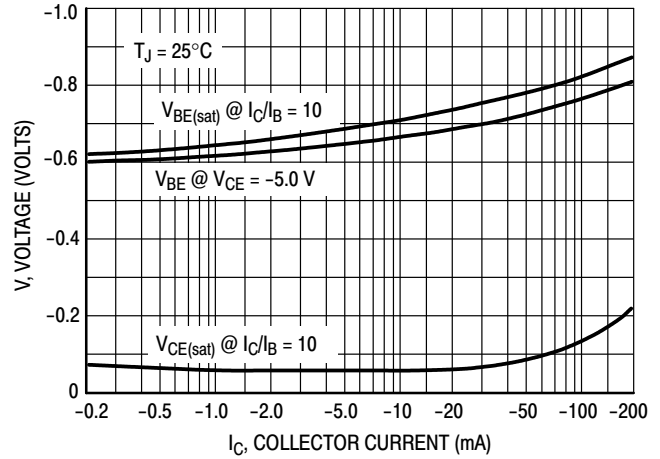


Figure 8. "On" Voltage

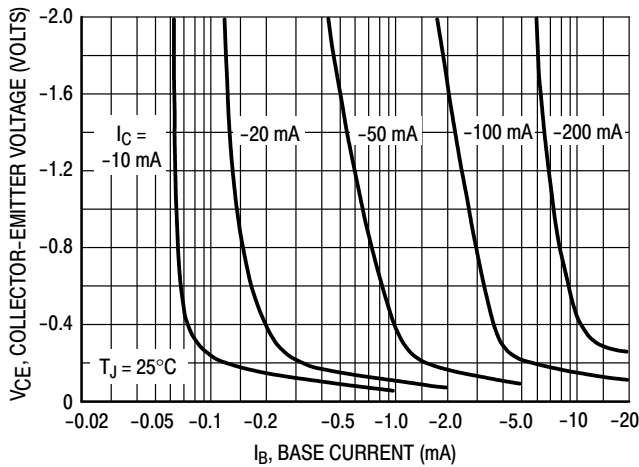


Figure 9. Collector Saturation Region

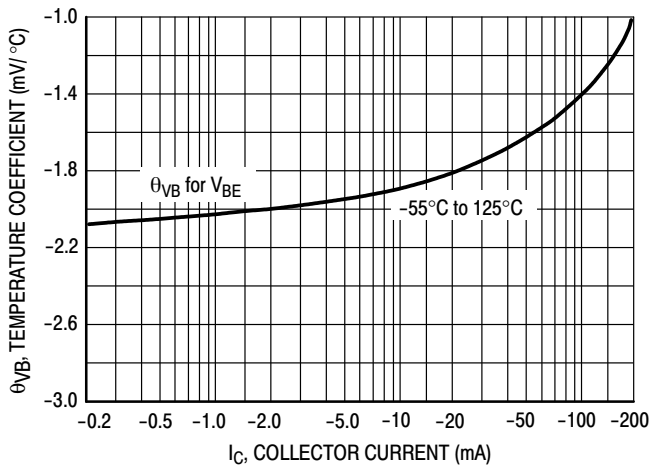


Figure 10. Base-Emitter Temperature Coefficient

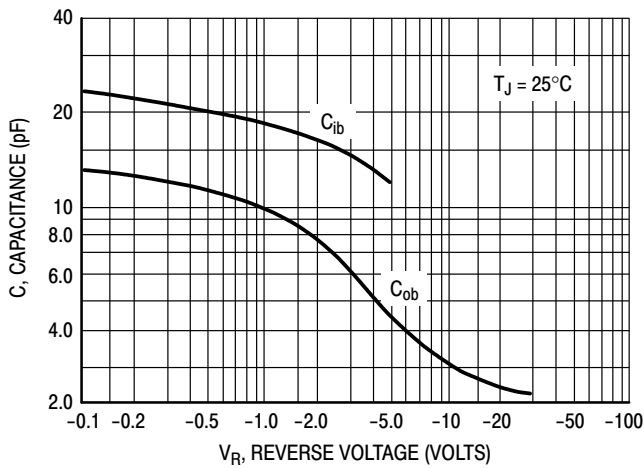


Figure 11. Capacitance

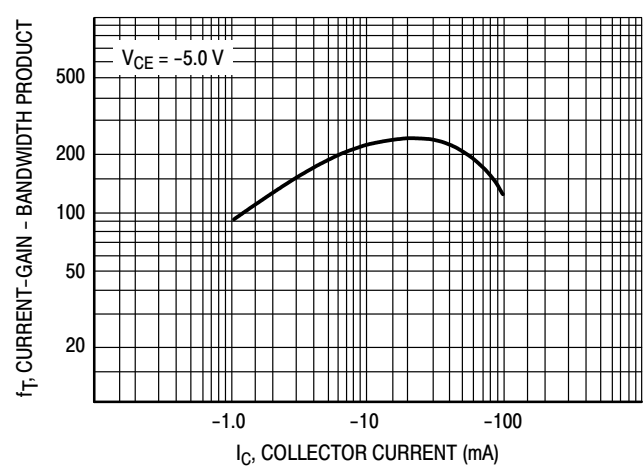


Figure 12. Current-Gain - Bandwidth Product

## BC856ALT1G Series

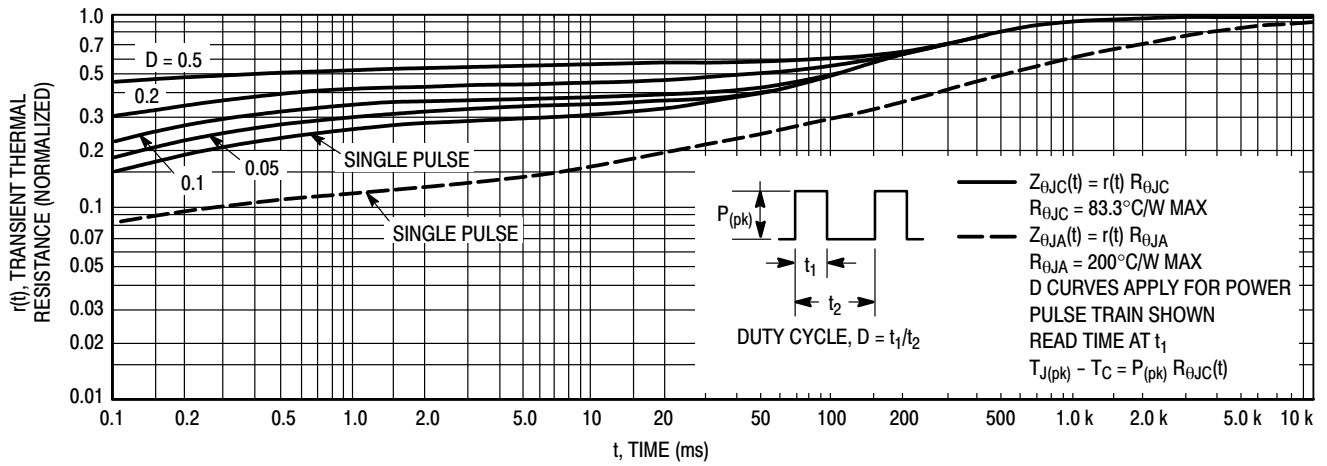


Figure 13. Thermal Response

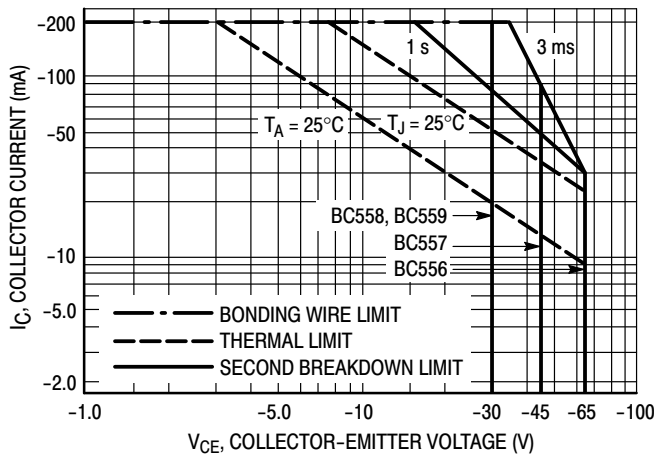


Figure 14. Active Region Safe Operating Area

The safe operating area curves indicate  $I_C$ - $V_{CE}$  limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 14 is based upon  $T_{J(pk)} = 150^\circ\text{C}$ ;  $T_C$  or  $T_A$  is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided  $T_{J(pk)} \leq 150^\circ\text{C}$ .  $T_{J(pk)}$  may be calculated from the data in Figure 13. At high case or ambient temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by the secondary breakdown.

## BC856ALT1G Series

### ORDERING INFORMATION

| Device         | Marking | Package             | Shipping <sup>†</sup> |
|----------------|---------|---------------------|-----------------------|
| BC856ALT1G     | 3A      | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| SBC856ALT1G*   |         |                     |                       |
| BC856ALT3G     |         |                     | 10,000 / Tape & Reel  |
| BC856BLT1G     | 3B      | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| SBC856BLT1G*   |         |                     |                       |
| BC856BLT3G     |         |                     | 10,000 / Tape & Reel  |
| SBC856BLT3G*   |         |                     |                       |
| BC857ALT1G     | 3E      | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| SBC857ALT1G*   |         |                     |                       |
| BC857BLT1G     | 3F      | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| SBC857BLT1G*   |         |                     |                       |
| BC857BLT3G     |         |                     | 10,000 / Tape & Reel  |
| NSVBC857BLT3G* |         |                     |                       |
| BC857CLT1G     | 3G      | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| SBC857CLT1G*   |         |                     |                       |
| BC857CLT3G     |         |                     | 10,000 / Tape & Reel  |
| BC858ALT1G     | 3J      | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| BC858BLT1G     | 3K      | SOT-23<br>(Pb-Free) |                       |
| NSVBC858BLT1G* |         |                     |                       |
| BC858BLT3G     | 3L      | SOT-23<br>(Pb-Free) | 10,000 / Tape & Reel  |
| BC858CLT1G     |         | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| BC858CLT3G     |         | SOT-23<br>(Pb-Free) | 10,000 / Tape & Reel  |
| BC859BLT1G     | 4B      | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| BC859BLT3G     |         | SOT-23<br>(Pb-Free) | 10,000 / Tape & Reel  |
| BC859CLT1G     | 4C      | SOT-23<br>(Pb-Free) | 3,000 / Tape & Reel   |
| BC859CLT3G     |         | SOT-23<br>(Pb-Free) | 10,000 / Tape & Reel  |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

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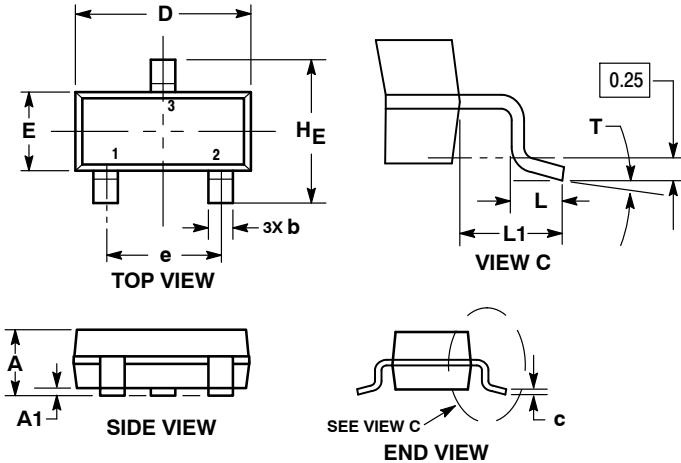
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### SOT-23 (TO-236) CASE 318-08 ISSUE AS

DATE 30 JAN 2018

SCALE 4:1

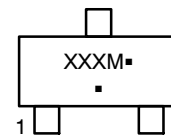


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| DIM | MILLIMETERS |      |      | INCHES |       |       |
|-----|-------------|------|------|--------|-------|-------|
|     | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| A   | 0.89        | 1.00 | 1.11 | 0.035  | 0.039 | 0.044 |
| A1  | 0.01        | 0.06 | 0.10 | 0.000  | 0.002 | 0.004 |
| b   | 0.37        | 0.44 | 0.50 | 0.015  | 0.017 | 0.020 |
| c   | 0.08        | 0.14 | 0.20 | 0.003  | 0.006 | 0.008 |
| D   | 2.80        | 2.90 | 3.04 | 0.110  | 0.114 | 0.120 |
| E   | 1.20        | 1.30 | 1.40 | 0.047  | 0.051 | 0.055 |
| e   | 1.78        | 1.90 | 2.04 | 0.070  | 0.075 | 0.080 |
| L   | 0.30        | 0.43 | 0.55 | 0.012  | 0.017 | 0.022 |
| L1  | 0.35        | 0.54 | 0.69 | 0.014  | 0.021 | 0.027 |
| HE  | 2.10        | 2.40 | 2.64 | 0.083  | 0.094 | 0.104 |
| T   | 0°          | ---  | 10°  | 0°     | ---   | 10°   |

### GENERIC MARKING DIAGRAM\*



XXX = Specific Device Code  
M = Date Code  
■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present.

### RECOMMENDED SOLDERING FOOTPRINT



DIMENSIONS: MILLIMETERS

STYLE 1 THRU 5:  
CANCELLED

STYLE 6:  
PIN 1. BASE  
2. EMITTER  
3. COLLECTOR

STYLE 7:  
PIN 1. EMITTER  
2. BASE  
3. COLLECTOR

STYLE 8:  
PIN 1. ANODE  
2. NO CONNECTION  
3. CATHODE

STYLE 9:  
PIN 1. ANODE  
2. ANODE  
3. CATHODE

STYLE 10:  
PIN 1. DRAIN  
2. SOURCE  
3. GATE

STYLE 11:  
PIN 1. ANODE  
2. CATHODE  
3. CATHODE-ANODE

STYLE 12:  
PIN 1. CATHODE  
2. CATHODE  
3. ANODE

STYLE 13:  
PIN 1. SOURCE  
2. DRAIN  
3. GATE

STYLE 14:  
PIN 1. CATHODE  
2. GATE  
3. ANODE

STYLE 15:  
PIN 1. GATE  
2. CATHODE  
3. ANODE

STYLE 16:  
PIN 1. ANODE  
2. CATHODE  
3. CATHODE

STYLE 17:  
PIN 1. NO CONNECTION  
2. ANODE  
3. CATHODE

STYLE 18:  
PIN 1. NO CONNECTION  
2. CATHODE  
3. ANODE

STYLE 19:  
PIN 1. CATHODE  
2. ANODE  
3. CATHODE-ANODE

STYLE 20:  
PIN 1. CATHODE  
2. ANODE  
3. GATE

STYLE 21:  
PIN 1. GATE  
2. SOURCE  
3. DRAIN

STYLE 22:  
PIN 1. RETURN  
2. OUTPUT  
3. INPUT

STYLE 23:  
PIN 1. ANODE  
2. ANODE  
3. CATHODE

STYLE 24:  
PIN 1. GATE  
2. DRAIN  
3. SOURCE

STYLE 25:  
PIN 1. ANODE  
2. CATHODE  
3. GATE

STYLE 26:  
PIN 1. CATHODE  
2. ANODE  
3. NO CONNECTION

STYLE 27:  
PIN 1. CATHODE  
2. CATHODE  
3. CATHODE

STYLE 28:  
PIN 1. ANODE  
2. ANODE  
3. ANODE

DOCUMENT NUMBER: 98ASB42226B

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DESCRIPTION: SOT-23 (TO-236)

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